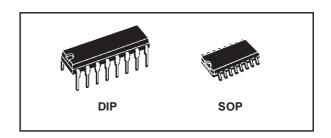


HCF4051B

SINGLE 8-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

- LOW "ON" RESISTANCE: 125Ω (Typ.)
 OVER 15V p.p SIGNAL-INPUT RANGE FOR
 V_{DD} V_{EE} = 15V
- HIGH "OFF" RESISTANCE : CHANNEL LEAKAGE ± 100pA (Typ.) at V_{DD} V_{EE} = 18V
- BINARY ADDRESS DECODING ON CHIP
- HIGH DEGREE OF LINEARITY : < 0.5% DISTORTION TYP. at f_{IS} = 1KHz, V_{IS} = 5 V_{pp} , V_{DD} V_{SS} ≥ 10V, RL = 10K Ω
- VERY LOW QUIESCENT POWER DISSIPATION UNDER ALL DIGITAL CONTROL INPUT AND SUPPLY CONDITIONS: 0.2 µW (Typ.) at V_{DD} - V_{SS} = V_{DD} - V_{EE} =10V
- MATCHED SWITCH CHARACTERISTICS : $R_{ON} = 5Ω$ (Typ.) FOR $V_{DD} V_{EE} = 15V$
- WIDE RANGE OF DIGITAL AND ANALOG SIGNAL LEVELS: DIGITAL 3 to 20, ANALOG TO 20V p.p.
- QUIESCENT CURRENT SPECIFIED UP TO 20V
- 5V. 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I_I = 100nA (MAX) AT V_{DD} = 18V T_A = 25°C
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"



ORDER CODES

PACKAGE	TUBE	T & R
DIP	HCF4051BEY	
SOP	HCF4051BM1	HCF4051M013TR

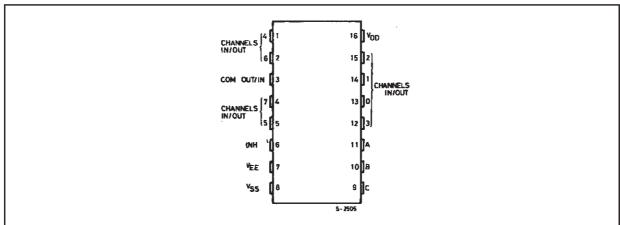
DESCRIPTION

The HCF4051B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. The HCF4051B analog multiplexer/demultiplexer

is a digitally controlled analog switch having low ON impedance and very low OFF leakage current. This multiplexer circuit dissipate extremely low quiescent power over the full V_{DD} - V_{SS} and V_{DD} - V_{EE} supply voltage range, independent of the logic state of the control signals.

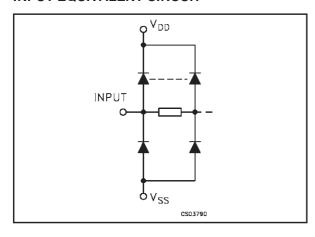
When a logic "1" is present at the inhibit input terminal all channel are off. This device is a single 8-channel multiplexer having three binary control inputs, A, B, and C, and an inhibit input. The three binary signals select 1 of 8 channels to be turned on, and connect one of the 8 inputs to the output.

PIN CONNECTION



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INPUT EQUIVALENT CIRCUIT



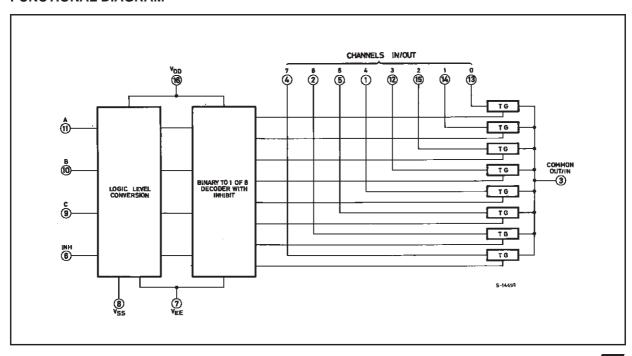
PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
11, 10, 9	A, B, C	Binary Control Inputs
6	INH	Inhibit Inputs
13, 14, 15, 12, 1, 5, 2, 4	0 to 7 CHANNEL IN/OUT	Indipendent inputs/out- puts
3	COM OUT/ IN	Common Output/Input
7	V_{EE}	Supply Voltage
8	V _{SS}	Negative Supply Voltage
16	V_{DD}	Positive Supply Voltage

TRUTH TABLE

IN	PUT STATES			"ON" CHANNEL (S)
INHIBIT	С	В	Α	ON CHANNEL (3)
0	0	0	0	0
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	X	Х	Х	NONE

FUNCTIONAL DIAGRAM



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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DD}	Supply Voltage	-0.5 to +22	V
V _I	DC Input Voltage	-0.5 to V _{DD} + 0.5	V
l _l	DC Input Current	± 10	mA
P_{D}	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T _{op}	Operating Temperature	-55 to +125	°C
T _{stg}	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V_{SS} pin voltage.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	3 to 20	V
V _I	Input Voltage	0 to V _{DD}	V
T _{op}	Operating Temperature	-55 to 125	°C

DC SPECIFICATIONS

		Test Condition				Value							
Symbol	Parameter	V _{IS}	V _{EE}	V _{SS}	V _{DD}	Т	A = 25°	С	-40 to	85°C	-55 to	125°C	Unit
		(V)	(V)	(V)	(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
ΙL	Quiescent Device				5		0.04	5		150		150	
	Current (all				10		0.04	10		300		300	μΑ
	switches ON or all switches OFF)				15		0.04	20		600		600	μΛ
	- Switchies Of 1)				20		0.08	100		3000		3000	
SWITCH							_						
R _{ON}	Resistance	0 <u><</u> V ₁ <u><</u>			5		470	1050		1200		1200	
		V _{DD}	0	0	10		180	400		520		520	Ω
		DD			15		125	280		360		360	
Δ_{ON}	Resistance Δ_{RON}	0 <u>≤</u> V ₁ <u>≤</u>			5		10						
	(between any 2 of 4 switches)	V _{DD}	0	0	10		10						Ω
	,	00			15		5						
OFF*	Channel Leakage Current (All Channel OFF) (COMMON O/I)		0	0	18		±0.1	100		1000		1000	nA
OFF*	Channel Leakage Current (Any Channel OFF)		0	0	18		±0.1	100		1000		1000	nA
C _I	Input Capacitance						5						
Co	Output Capacitance		-5	-5	5		30						pF
C _{IO}	Feedthrough	1					0.2						
CONTRO	L (Address or Inhi	bit)		ı		•	•						
V _{IL}	Input Low Voltage		V =	= V _{SS}	5			1.5		1.5		1.5	
				1KΩ	10			3		3		3	V
		= VDD thru	to \		15			4		4		4	
V _{IH}	Input High Voltage	1ΚΩ		2μΑ	5	3.5			3.5		3.5		
			`	OFF	10	7			7		7		V
			chan	nels)	15	11			11		11		
I _{IH,} I _{IL}	Input Leakage Current	VI	= 0/18\	/	18		±10 ⁻³	±0.1		±1		±1	μΑ
Cı	Input Capacitance						5	7.5					pF

^{*} Determined by minimum feasible leakage measurement for automating testing.

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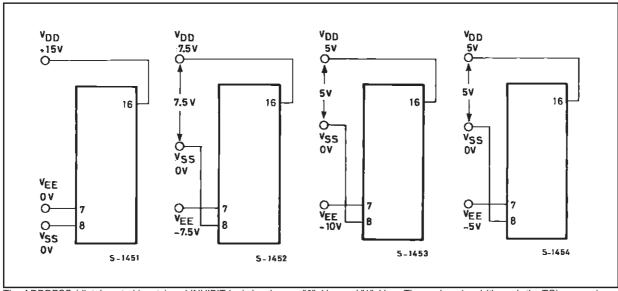
DYNAMIC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$, $C_{L} = 50 pF$, all input square wave rise and fall time = 20 ns)

				Test Co	ndition				Value		Unit
Parameter	V _{EE} (V)	R _L (ΚΩ)	f _I (KHz)	V _I (V)	V _{SS} (V)	V _{DD} (V)		Min.	Тур.	Max.	
Propagation Delay				V _{DD}		5			30	60	
Time (signal input to		200		V DD		10]		15	30	ns
output)						15			11	20	
Frequency Response Channel "ON" (sine	= V _{SS}	1		E/*\		10	V _O at Common OUT/IN		20		MHz
wave input) at $20 \log V_O/V_I = -3dB$	- vss	'		5(*)		10	V _O at any channel		60		IVITIZ
Feedthrough (all channels OFF) at	\/	4		F(*)		40	V _O at Common OUT/IN		12		N 41 1-
$20 \log V_{O}/V_{I} = -40 dB$	= V _{SS}	1		5(*)		10	V _O at any channel		8		MHz
Frequency Signal Crosstalk at 20 log V _O /V _I = -40dB	= V _{SS}	1		5(*)		10	Between any 2 channels		3		MHz
O's a Maria D'atantia				2(*)		5			0.3		
Sine Wave Distortion $f_{IS} = 1KHz$ Sine Wave	= V _{SS}	10	1	3(*)		10	1		0.2		%
INS = TRITZ Office Wave				5(*)		15	1		0.12		1
CONTROL (Address	or Inhi bi	t)					•				
Propagation Delay:	0				0	5			360	720	
Address to Signal	0				0	10]		160	320]
OUT (Channels ON or OFF)	0				0	15	1		120	240	ns
	-5				0	5	1		225	450	1
Propagation Delay:	0				0	5			360	720	
Inhibit to Signal OUT	0				0	10	1		160	320	1
(Channel turning ON)	0	1			0	15	1		120	240	ns
	-10				0	5	1		200	400	
Propagation Delay:	0					5			200	450	
Inhibit to Signal OUT	0	40				10	1		90	210	
(Channel turning OFF)	0	10				15	1		70	160	ns
OFF)	-10					5	1		130	300	1
Address or Inhibit to Signal Crosstalk	0	10 ⁽¹⁾			0	10	$V_C = V_{DD} - V_{SS}$ (square wave)		65		mV peak

⁽¹⁾ Both ends of channel.

* Peak to Peak voltage symmetrical about (V_{DD} - V_{EE}) /2

TYPICAL BIAS VOLTAGES



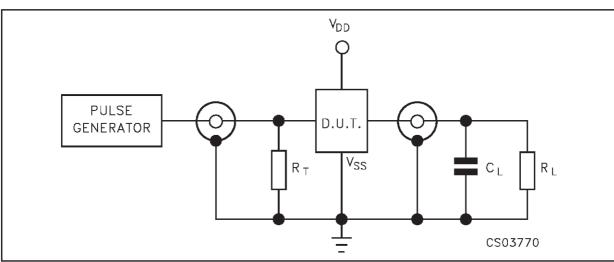
The ADDRESS (digtal-control inputs) and INHIBIT logic levels are: "0"=VSS and "1"=VDD. The analog signal (through the TG) may swing

SPECIAL CONSIDERATIONS

Control of analog signals up to 20V peak to peak can be achieved by digital signal amplitudes of 4.5 to 20V (if V_{DD} - V_{SS} = 3V, a V_{DD} - V_{EE} of up to 13V can be controlled; for V_{DD} - V_{EE} level differences above 13V, a V_{DD} - V_{SS} of at least 4.5V is required. For example, if V_{DD} = +5, V_{SS} = 0, and V_{EE} = -13.5, analog signals from -13.5V to 4.5V can be controlled by digital inputs of 0 to 4.5V. In

certain applications, the external load resistor current may include both $\rm V_{\rm DD}$ and signal-line components. To avoid drawing $\rm V_{\rm DD}$ current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed 0,8V (calculated from RON values shown in DC SPECIFICATIONS). No V_{DD} current will flow through R_I if the switch current flows into lead 3.

TEST CIRCUIT

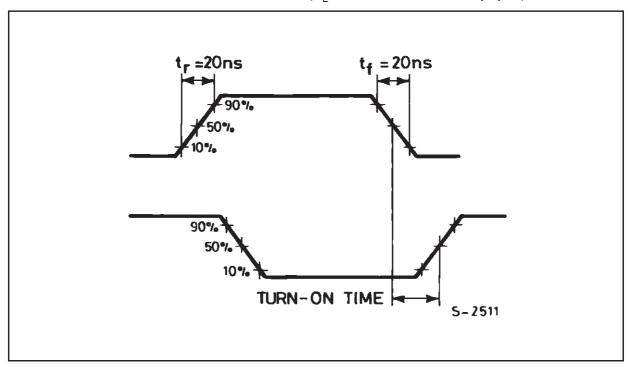


 $C_L = 50$ pF or equivalent (includes jig and probe capacitance)

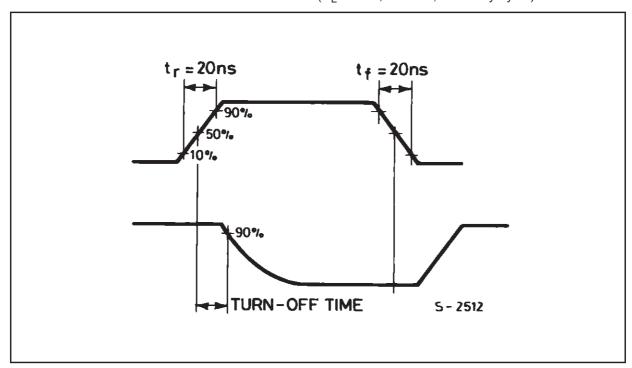
 $R_L = 200 K \Omega$ $R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

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WAVEFORM 1 : CHANNEL BEING TURNED ON ($R_L = 1 \text{K}\Omega$, f=1MHz; 50% duty cycle)



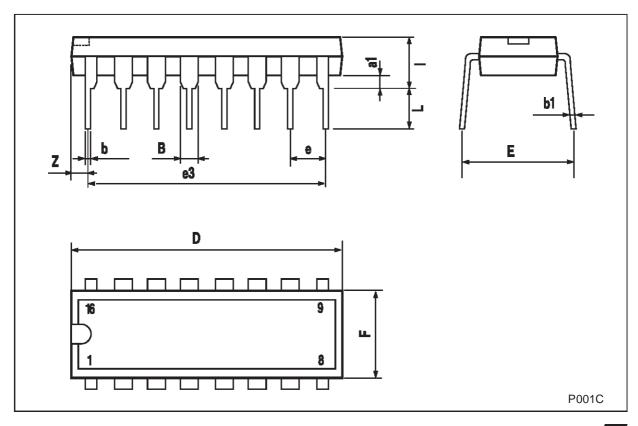
WAVEFORM 2 : CHANNEL BEING TURNED OFF (R_L = 1K Ω , f=1MHz; 50% duty cycle)



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Plastic DIP-16 (0.25) MECHANICAL DATA

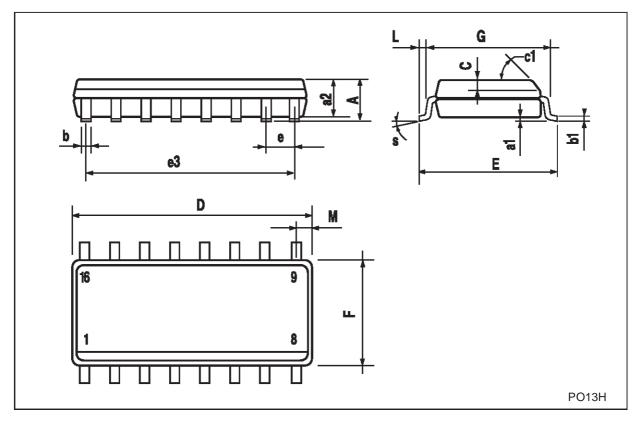
DIM.		mm.		inch			
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
a1	0.51			0.020			
В	0.77		1.65	0.030		0.065	
b		0.5			0.020		
b1		0.25			0.010		
D			20			0.787	
E		8.5			0.335		
е		2.54			0.100		
e3		17.78			0.700		
F			7.1			0.280	
I			5.1			0.201	
L		3.3			0.130		
Z			1.27			0.050	



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SO-16 MECHANICAL DATA

DIM		mm.		inch				
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
А			1.75			0.068		
a1	0.1		0.2	0.003		0.007		
a2			1.65			0.064		
b	0.35		0.46	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.019			
c1			45°	(typ.)				
D	9.8		10	0.385		0.393		
E	5.8		6.2	0.228		0.244		
е		1.27			0.050			
еЗ		8.89			0.350			
F	3.8		4.0	0.149		0.157		
G	4.6		5.3	0.181		0.208		
L	0.5		1.27	0.019		0.050		
М			0.62			0.024		
S			8° (r	max.)	•			



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